

**Amendments to the Specification:**

Please amend paragraph [0060] (page 17 bridging to page 18) as follows:

In other embodiments, the transfer device 130 can have other configurations. For example, the transfer device 130 can carry a single microelectronic workpiece 114 or more than two microelectronic workpieces 114. When the transfer device 130 carries more than one microelectronic workpiece 114, the motion of each microelectronic workpiece 114 can be at least partially independent, as described above with reference to Figures 4 and 5. Alternatively, the transfer device 130 can be configured to automatically move a plurality of microelectronic substrates 114 together in a batch arrangement, for example, with or without a separate carrier or container configured for use within the enclosure 102. Further details of aspects of transfer devices in accordance with other embodiments of the invention are included in U.S. Patent Application No. 09/875,300, filed June 5, 2001, U.S. Patent Application No. 10/080,910, now issued as U.S. Patent No. 6,749,391 \_\_\_\_\_(Attorney Docket No. 29195.8153US2), and published PCT Application No. PCT/US99/14414, all incorporated herein by reference.